

SEMICONDUCTOR TECHNICAL DATA

FA7019A/AF/AS ~ FA7045A/AF/AS

VOLTAGE DETECTOR

Function of this IC is accurately resetting the system after detecting voltage at the time of switching power on and instantaneous power off in various CPU systems and other logic systems.

FEATURES

- \cdot Current Consumption is Low. $I_{CCL} = 300 \mu A$ Typ. $I_{CCH} = 30 \mu A$ Typ.
- · Resetting Output Minimum Guarantee Voltage is Low 0.8V Typ.
- · Hysteresis Voltage is Provided. 50mV Typ.
- · Reset Signal Generation Starting Voltages :

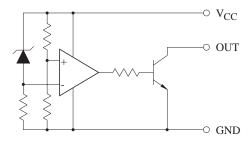
FA7019A/AF/AS	1.9V Typ.	FA7033A/AF/AS	3.3V Typ.
FA7021A/AF/AS	2.1V Typ.	FA7034A/AF/AS	3.4V Typ.
FA7023A/AF/AS	2.3V Typ.	FA7035A/AF/AS	3.5V Typ.
FA7025A/AF/AS	2.5V Typ.	FA7036A/AF/AS	3.6V Typ.
FA7027A/AF/AS	2.7V Typ.	FA7037A/AF/AS	3.7V Typ.
FA7029A/AF/AS	2.9V Typ.	FA7039A/AF/AS	3.9V Typ.
FA7031A/AF/AS	3.1V Typ.	FA7042A/AF/AS	4.2V Typ.
		FA7045A/AF/AS	4.5V Typ.

· Taping Type is also Available.

APPLICATIONS

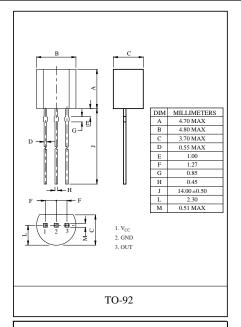
- (1) As Control Circuit of Battery-Backed Memory.
- (2) As Measure Against Erroneous Operations at Power ON-OFF.
- (3) As Measure Against System Runaway at Instantaneous Break of Power Supply etc.
- (4) As Resetting Function for the CPU-Mounted Equipment, such as Personal Computers, Printers, VTRs and so forth.

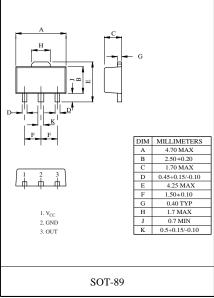
EQUIVALENT CIRCUIT

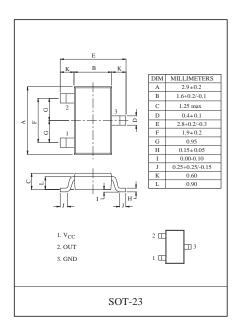


MAXIMUM RATINGS (Ta=25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Supply Voltage		Vcc	-0.3 ~ 15	V	
Power Dissipation (Package Limitation)	FA7019A~45A		400	mW	
	FA7019AF~45AF	PD	500		
	FA7019AS~45AS		350		
Operating Temperature		Topr	-30 ~ 75	°C	
Storage Temperature		Tstg	-55 ~ 150	°C	









2019. 06. 19

FA7019A/AF/AS ~ FA7045A/AF/AS

ELECTRICAL CHARACTERISTICS

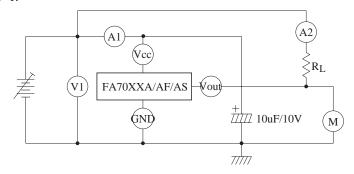
CHARACTERISTIC	SYMBOL	TEST CIRCUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Detecting Voltage		1	$R_{L}=200\Omega$ $V_{OL}\leq0.4V$	FA7019A/AF/AS FA7021A/AF/AS	1.75 1.95	1.9 2.1	2.05 2.25	V
				FA7023A/AF/AS	2.15	2.3	2.45	
				FA7025A/AF/AS	2.35	2.5	2.65	
				FA7027A/AF/AS	2.55	2.7	2.85	
				FA7029A/AF/AS	2.75	2.9	3.05	
				FA7031A/AF/AS	2.95	3.1	3.25	
	V_{S}			FA7033A/AF/AS	3.15	3.3	3.45	
				FA7034A/AF/AS	3.25	3.4	3.55	
				FA7035A/AF/AS FA7036A/AF/AS	3.35 3.45	3.5 3.6	3.65 3.75	
				FA7030A/AF/AS	3.45	3.7	3.85	
				FA7039A/AF/AS	3.75	3.9	4.05	
				FA7042A/AF/AS	4.05	4.2	4.35	
				FA7045A/AF/AS	4.35	4.5	4.65	
				FA/043A/AF/AS	4.33	4.3	4.03	
Low-Level Output Voltage	V _{OL}	1	R _L =200Ω		-	-	0.4	V
Output Leakage Current	I _{OH}	1	V _{CC} =15V		-	-	0.1	μΑ
Hysteresis Voltage	∆Vs	1	$R_L=200\Omega$		30	50	100	mV
Detecting Voltage Temperature Coefficient	Vs/⊿T	1	R _L =200Ω		-	±0.01	-	%/°C
Circuit Current at on Time	IccL	1	V _{CC} =Vsmin0.05V		-	300	500	μΑ
Circuit Current at off Time	IccH	1	V _{CC} =5.25V		-	30	50	μΑ
Threshold Operating Voltage	Vopr	1	$R_L=200\Omega$, $V_{OL} \leq 0.4V$		-	0.8	-	V
"L" Transmission Delay Time	tpHL	2	$R_L=1.0k\Omega$, $C_L=100pF$		-	10	-	μS
"H" Transmission Delay Time	tpLH	2	$R_L=1.0k\Omega$, $C_L=100pF$		-	15	-	μS
Output Current at on Time I	IoL I	1	V _{CC} =Vsmin0.05V, Tc=25 ℃		20	-	-	mA

2/4

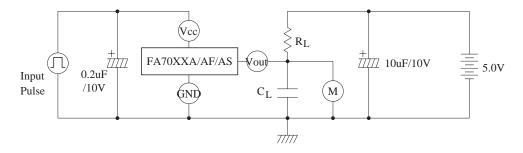


FA7019A/AF/AS ~ FA7045A/AF/AS

TEST CIRCUIT 1.

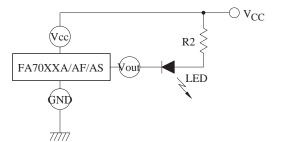


TEST CIRCUIT 2.

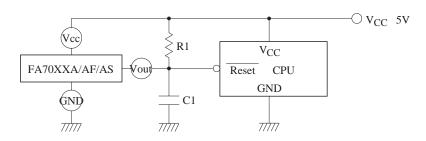


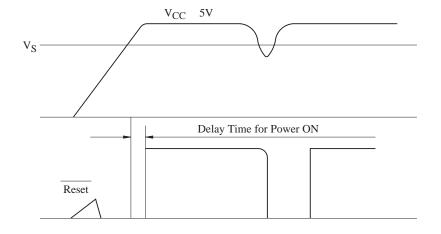
APPLICATION CIRCUIT

(1) BATTERY LOW INDICATOR



(2) CPU RESETTING





3/4

(NOTE)

2019. 06. 19

- (1) Connecting of LED and R2 obtains a voltage drop indicator.
- (2) Connecting of C1 and selection of time constant with C1 and R1 set the power on delay time.

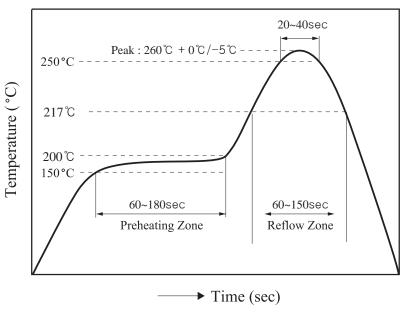
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PRECAUTION FOR USE

Lead-Free Soldering Condition.

Elements mounting styles of electronic devices are gaining in further diversification over recent years, and needs for components are all the more expanding in varieties. Especially, surface mounting is steadily penetrating into industrial segments as a world-wide popular technical trend. Although exposure to high temperature is inevitable during soldering we recommend limiting the soldering temperature to low levels as shown in figure for the sake of retaining inherent excellent reliability.



[Lead-Free Soldering Temperature Profile]

- 1. When employing solder reflow method
 - 1) Soldering Condition
 - ⓐ Standard Condition : 250 °C (Temperature), 10 ± 1 sec. (Time)
 - ⓑ Peak Condition : $260 \pm 3 \, ^{\circ}\mathrm{C}$
 - 2) Recommend temperature profile
 - 3) Precautions on heating method

When resin in kept exposed to high temperature for a long time, device reliability may be marred.

Therefore, it is essential to complete soldering in the shortest time possible to prevent temperature of resin from rising.

- When employing halogen lamps or infrared-ray heaters
 When halogen lamps or infrared-ray heaters are used, avoid direct irradiation onto resin surfaces; such devices cause extensive localized temperature rise.
- * Please keep a reflow solder operating when Surface Mount Package s Soldering.